

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











Dual Common Cathode Schottky Rectifier

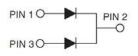
FEATURES

- Low power loss, high efficiency
- Guardring for overvoltage protection
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

definition









MECHANICAL DATA

Case: ITO-220AB

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - halogen-free Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity: As marked

Mounting torque: 5 in-lbs maximum **Weight:** 1.7 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)											
		MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	
PARAMETER	SYMBOL	2035	2045	2050	2060	2080	2090	20100	20150	20200	UNIT
		СТ	СТ	СТ	СТ	СТ	СТ	СТ	СТ	СТ	
Maximum repetitive peak reverse voltage	V_{RRM}	35	45	50	60	80	90	100	150	200	V
Maximum RMS voltage	V_{RMS}	24	31	35	42	56	63	70	105	140	V
Maximum DC blocking voltage	V_{DC}	35	45	50	60	80	90	100	150	200	V
Maximum average forward rectified current	I _{F(AV)}					20					Α
Peak repetitive forward current (Rated VR, Square wave, 20KHz)	I _{FRM}	20				Α					
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	150				Α					
Peak repetitive reverse surge current (Note 1)	I _{RRM}	1 0.5				Α					
Maximum instantaneous forward voltage (Note 2) I_F = 10 A, T_J =25°C I_F = 10 A, T_J =125°C I_F = 20 A, T_J =25°C I_F = 20 A, T_J =125°C	V _F	0. 0.	80 57 84 72	0. 0.	80 70 95 85	0.80 0.65 1.00 0.75	0. 0.	85 75 95 85	0. 1.	95 85 05 95	V
Maximum reverse current @ rated VR T _J =25 ℃	I_	0.1							mA		
T _J =125 ℃	I _R	1	5	1	0	30	,	5	:	2	'''
Voltage rate of change (Rated V_R)	dV/dt	10000			V/µs						
Isolation voltage from terminals to heatsink with t=1.0 min	V _{AC}	1500				٧					
Typical thermal resistance	$R_{\theta JC}$	1.5 3.5			°C/W						
Operating junction temperature range	TJ	- 55 to +150			οС						
Storage temperature range	T _{STG}	- 55 to +150		οС							

Note 1: tp = $2.0 \mu s$, $1.0 \overline{Hz}$

Note 2: Pulse test with PW=300µs, 1% duty cycle

Document Number: D1308017 Version: N13



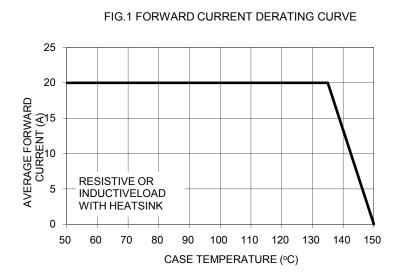
ORDERING INFORMATION						
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING	
	QUALIFIED		CODE			
MBRF20xxCT (Note 1)	Prefix "H"	C0	Suffix "G"	ITO-220AB	50 / Tube	

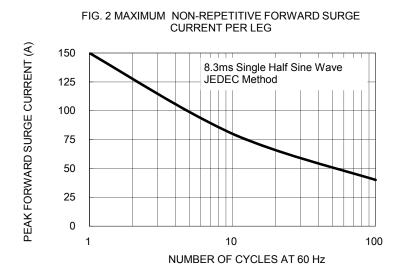
Note 1: "xx" defines voltage from 35V (MBRF2035CT) to 200V (MBRF20200CT)

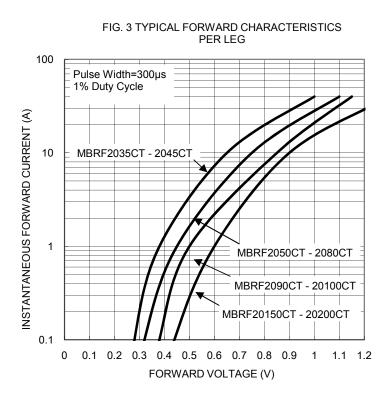
EXAMPLE							
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND	DESCRIPTION		
MBRF2060CT C0	MBRF2060CT		C0				
MBRF2060CT C0G	MBRF2060CT		C0	G	Green compound		
MBRF2060CTHC0	MBRF2060CT	Н	C0		AEC-Q101 qualified		

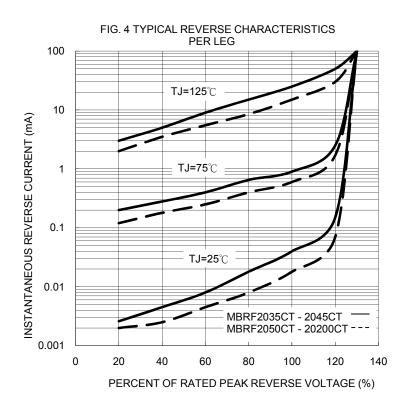
RATINGS AND CHARACTERISTICS CURVES

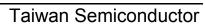
(TA=25°C unless otherwise noted)



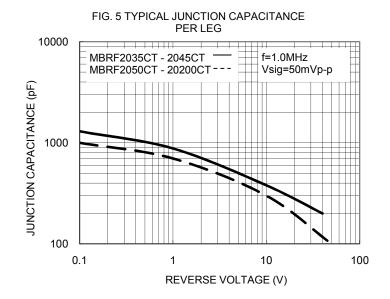


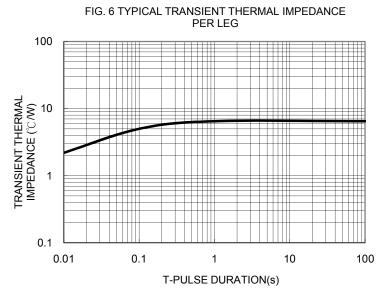




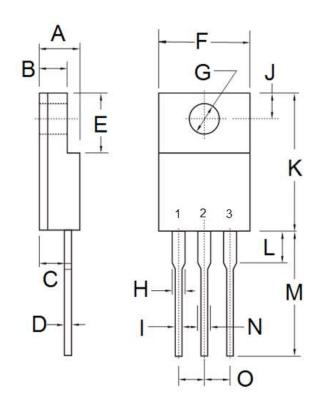








PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
DIN.	Min	Max	Min	Max		
Α	4.30	4.70	0.169	0.185		
В	2.50	3.16	0.098	0.124		
C	2.30	2.96	0.091	0.117		
D	0.46	0.76	0.018	0.030		
Е	6.30	6.90	0.248	0.272		
F	9.60	10.30	0.378	0.406		
G	3.00	3.40	0.118	0.134		
Η	0.95	1.45	0.037	0.057		
	0.50	0.90	0.020	0.035		
J	2.40	3.20	0.094	0.126		
K	14.80	15.50	0.583	0.610		
L	-	4.10	-	0.161		
М	12.60	13.80	0.496	0.543		
N	-	1.80	-	0.071		
0	2.41	2.67	0.095	0.105		

Version: N13

MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound YWW = Date Code

= Factory Code

Document Number: D1308017





Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied,to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or seling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Document Number: D1308017 Version: N13